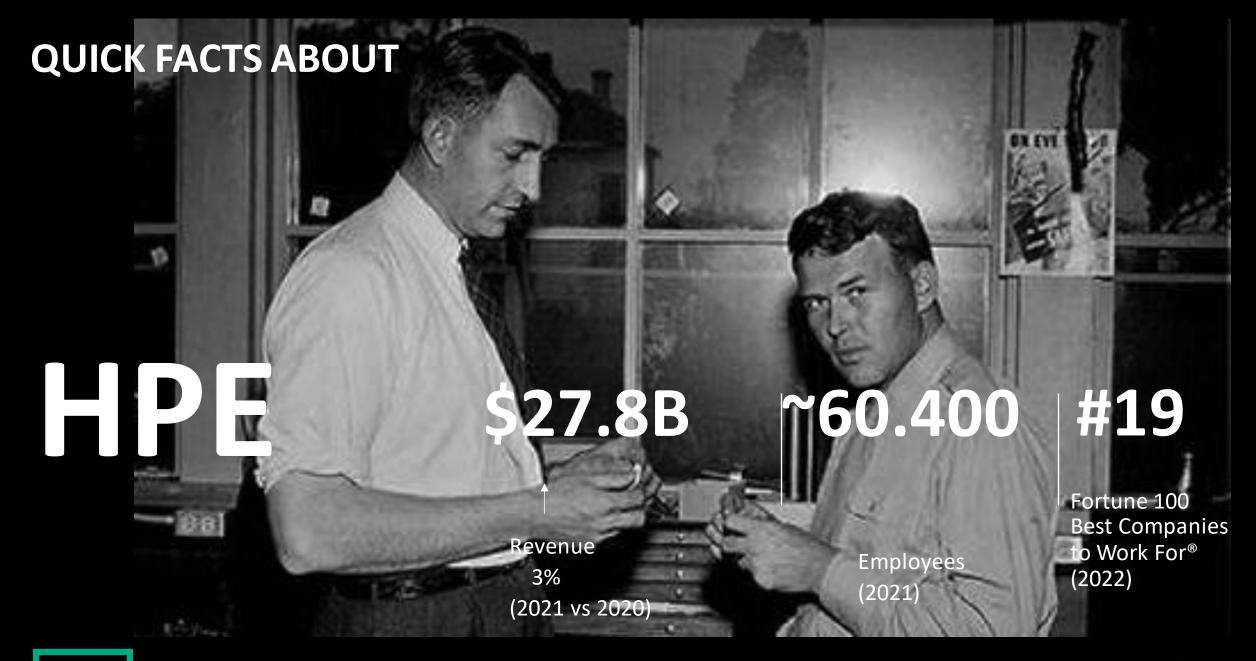
HPE Services for HPC and Liquid Cooled solutions

EurOpen Martin Papik, May 2023



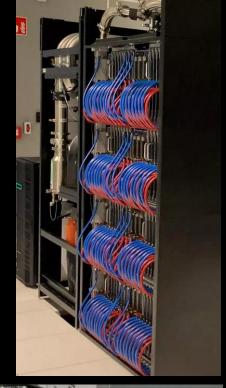


ATLANTIS

1st November 2022 - Official opening ceremony







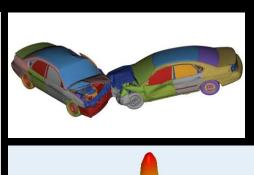


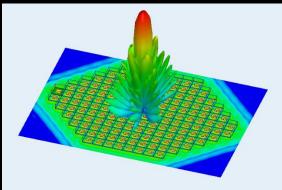


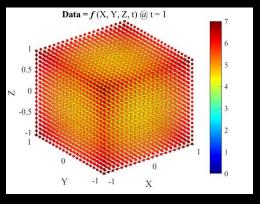


HIGH PERFORMANCE COMPUTING MARKET

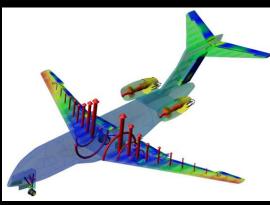
- Human genome sequencing
- Nuclear Stockpile Simulation
- Airplane/car manufacturers
- Military systems, Security/Intelligence
- Rendering farms, Entertainment industry
- Oil & Gas, reservoir simulation, seismic...
- Chemistry
- Banks, Financial markets
- Formula 1
- Weather forecast
- Universities Theoretical Science



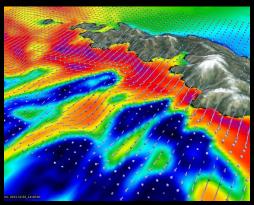


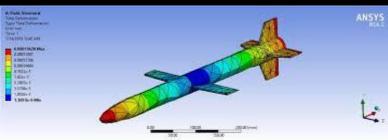






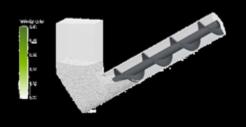


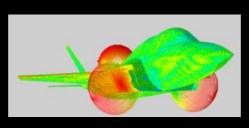




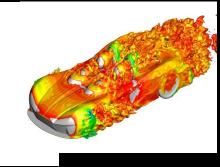


WHAT DO THESE COMPUTE PROBLEMS HAVE IN COMMON?









- -High complexity
- -High number of coupled / related tasks
- -Single node memory exhaustion
- => **Divide et Impera** is possible solution



Philip II of Macedor

Challenging to distribute across multiple nodes in an HPC cluster. Want to **solve** "holistically" as one virtual node.

Compete for "fat nodes" (with more processors/memory), compounding time and effort to discovery

Or too big for the one node

If memory is exhausted, simulation fails (hours wasted)

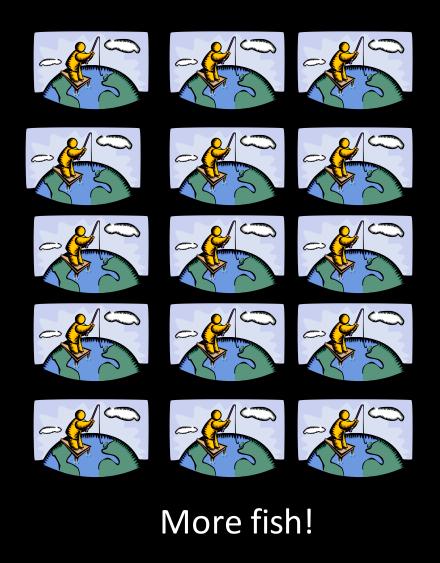
Use smaller models, reducing accuracy and increasing prototype costs/time to production

PARALLELISM

Parallelism means doing multiple things at the same time: you can get more work done in the same time.

Less fish ...







MPI

Cray MPI HPE MPI Slingshot Fabric InfiniBand Support for InfiniBand in June 2020 Packaging **Cray Programming Environment** HPE Message Passing Interface (MPI) **Cray Supercomputers Platforms** HPE Apollo, HPE ProLiant DL HPE Apollo & HPE ProLiant DL in June 2020 Tuned for AMD, Intel, Arm and GPUs Tuned for AMD, Intel, Arm and GPUs MPI profiling and guided placement tools CrayPAT optimizes rank ordering More facts Works with Cray's Linux Environment XPMEM and Boost runtime performance for any MPI app w/o **Huge Pages** recompile OS: Cray Linux Environment, RHEL OS: RHEL, SLES, CentOS, TOSS

Why HPE go into Liquid?



Why Liquid Cooling?

Performance

Reliable top-bin CPU/GPU operation
Sustained turbo modes

Density

More servers per rack Fewer racks required

Efficiency

More effective heat capture Lower cooling power required

HPE Server Solutions for Liquid Cooling systems



HPC LIQUID COOLING - OVERVIEW

Hybrid Cooling solutions

How it works:

Liquid to air cooling AND direct liquid cooling (slow convergence into Direct Liquid technologies)



ARC Rack +



Apollo 2000 DLC and XD (near future)

Direct Liquid Cooling solutions

How it works:

Coolant flows through cold-plates to extract heat directly from all server components



Cray EX Lite



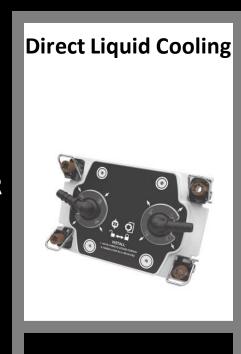
Cray EX



HPE Server Cooling Options



100% heat to air 0% heat to liquid



30% heat to air 70% heat to liquid

OPTIONALADDITIONAL COOLING

Can be used with air cooled or liquid cooled servers



Uses facility water to neutralize exhaust hot air back to room neutral temperatures



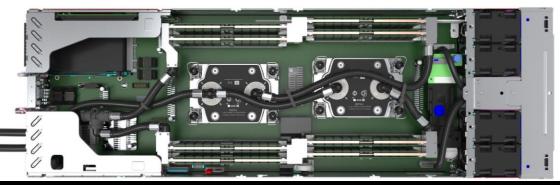
OR

Encapsulates the IT via sealed racks and uses facility water to cool air-cooling system

HPE HYBRID LIQUID COOLING – AIR/DLC

DLC - Direct Liquid Cooling provide to the hottest components in the server such as the CPU/GPU, memory DIMMs while using air cooling to cool the remaining low heat components

- Rack comes with pre-installed rack mounted CDU and manifolds
- Can be 100% liquid cooled when accompanied with RDHX or ARCS
- Racks can be populated partly and scale over time (Scale UP and OUT). They come pre-filled with coolant.
- Supports top or bottom feed facility water (universal)
- Easy to adapt DC







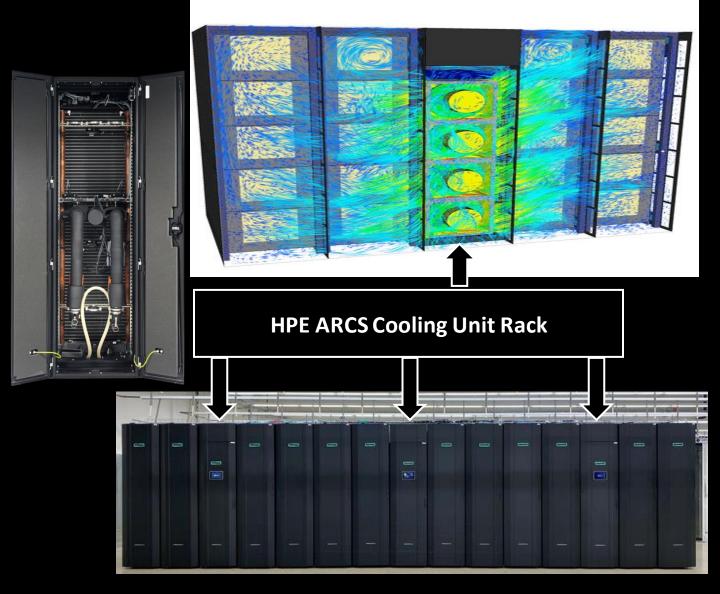




HPE Cray XD 2000 + ARCS

The HPE ARCS uses a closed-loop, room-agnostic design capable of cooling fully populated racks, even with top bin CPUs. The horizontal airflow of the HPE Adaptive Rack Cooling system fully supports Apollo, XD, DL, and ClusterStor E1000, and industry-standard front-to-back hardware.

- Allows for in-rack IT cooling without adding to the heat load in the data center.
- Implementation of variable speed fans within ARCS enables improved energy efficiencies by providing the right volume of airflow to all IT regardless of mounting position or workload.
- Acoustic benefits and reduced number of water taps bring advantages over other rack-level cooling products.
- ARCS enables customer datacenter power density to increase without need for facilities upgrades.





HPE CRAY EX LITE

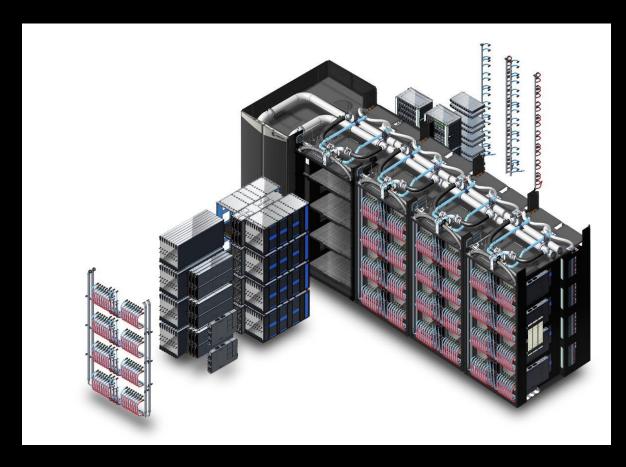
Cray EX Lite provides DLC (Direct Liquid Cooling) to all components in the server, including CPU/GPU, memory, voltage regulators, etc.

- Mainly AMD based CPU and GPU design now
- Racks can be populated one chassis at a time and scale over time. Pre-filled with coolant and ready to connect to existing system.
- Dedicated in-rack CDU, allows additional Cray EX Lite cabinets to be added to the existing cluster over time
- Up to 96 nodes per cabinet
- Integrated liquid cooled switches
- 100% liquid cooling solution
- Supports top or bottom feed facility water





HPE CRAY EX

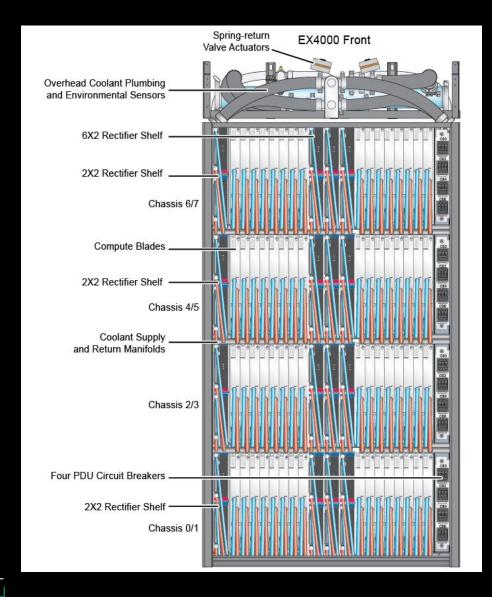


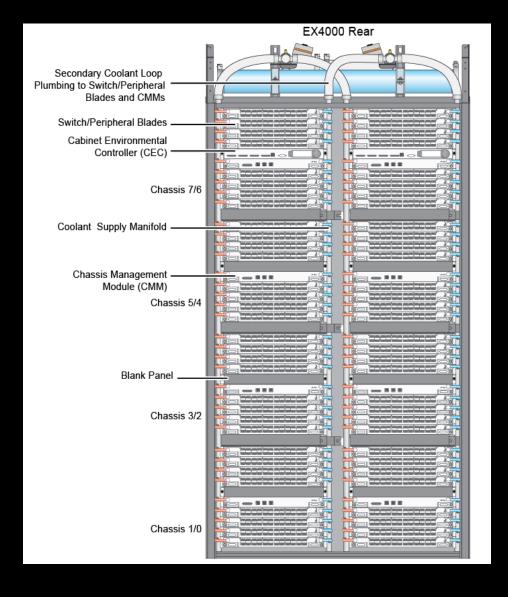
Cray EX provides DLC (Direct Liquid Cooling) to all components in the server, including CPU/GPU, memory, voltage regulators, etc.

- Supports the latest top bin CPU & GPU technology
- Best option for high performance computing deployments exceeding 1000+ nodes
- Large row-based CDUs manage coolant for multiple cabinets
- Up to 256 nodes per cabinet
- 1 CDU per 4 Compute racks
- Racks are heavy and nonstandard dimensions special DC requirements
- Management rack with DL3x5 need to be supplied for HPCM and other sw.



HPE CRAY EX - Detail







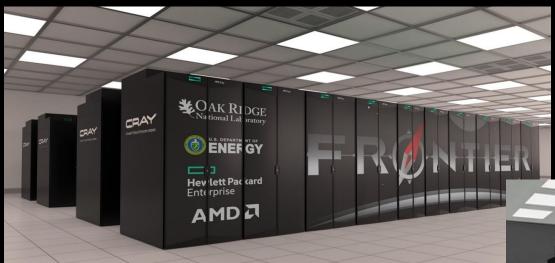
Blade Detail

- EX425
- AMD based
- 4 servers per blade





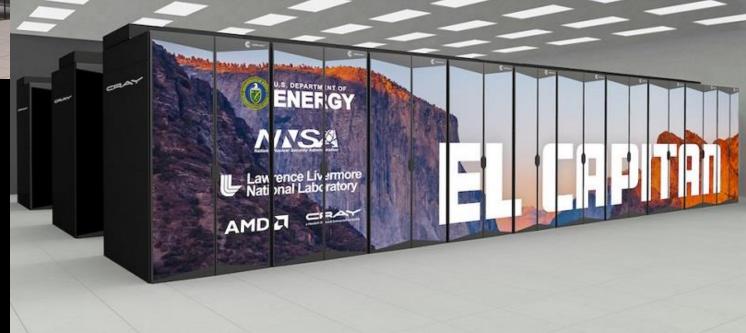
EXASCALE HPC GOAL COMPLETED 2022!!!



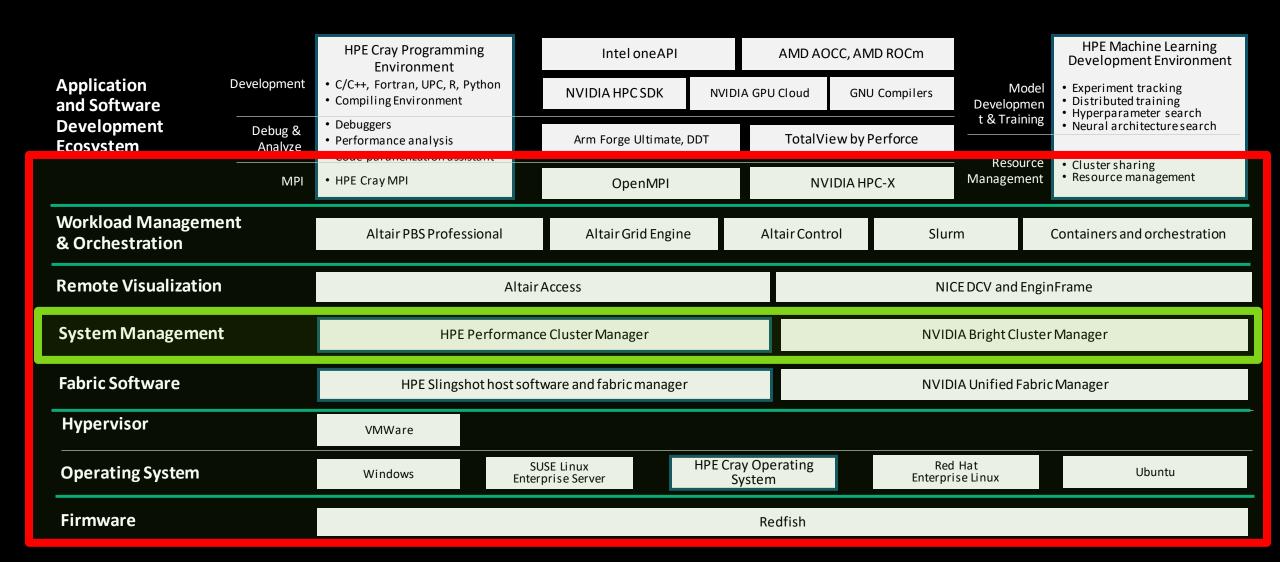
El Capitan, an HPE-built, AMD-powered exascale system, is on track to deliver at least **2 exaflops** of peak performance.

HPE CRAY EX

- -Up to 64 compute blades, and 512 processors per rack
- -Flexible bladed architecture supports multiple generations of CPUs, GPUs, and interconnect
- -100% direct liquid cooling
- -Scales to 100s of cabinets



Comprehensive software portfolio for HPE Cray XD systems / GIC services for HPC





NEXT MISSION: SPACEBORNE COMPUTER-2

LAUNCHED: 20-FEB 2021 ABOARD NORTHROP GRUMMAN'S NG-15







Thank you

martin.papik@hpe.com

